



Fabrication and High-Heat-Flux-Testing of W/Cu-divertor modules with a graded interface

Research-project of the “Friedrich-Schiedelstiftung für Energietechnik”

Actively cooled divertor test modules

W macrobrush mock-up

- coating of W-tiles with OFHC-Cu
- e-beam welding to CuCrZr heat sink

HHF test

1000 cycles @ **18** MWm⁻²
without failure



PS-W mock-up

- vacuum plasma spraying of tungsten

HHF test

1000 cycles @ **5.5** MWm⁻²
without failure
430 cycles @ 7.6 MWm⁻²
increasing T_{surf}

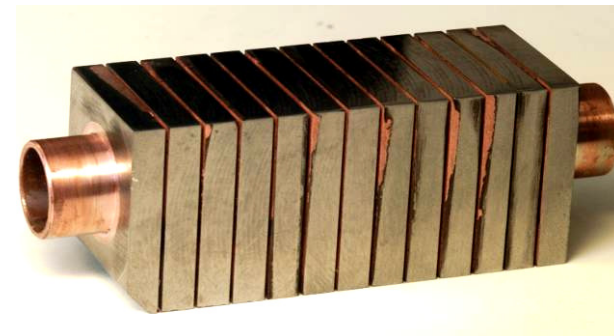


W monoblock (monolytic type)

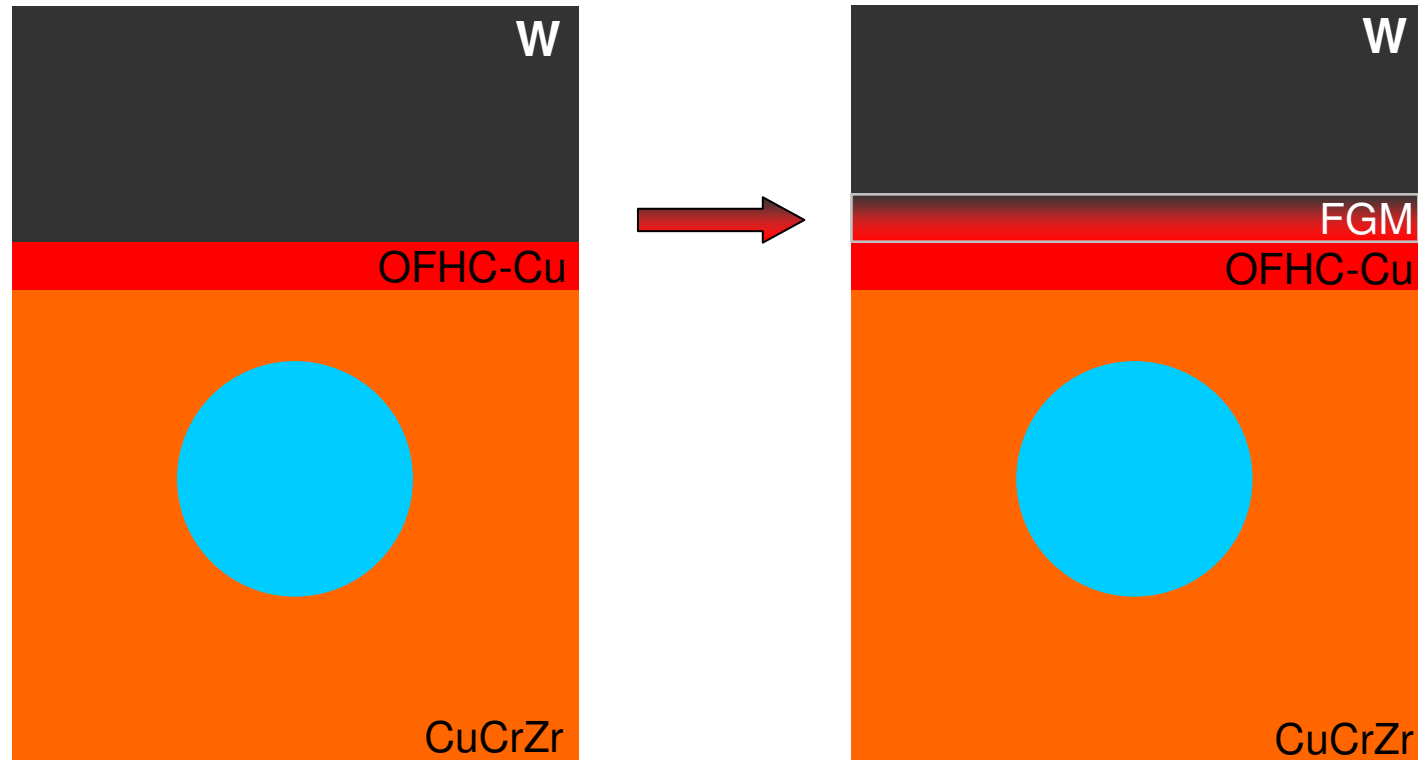
- drilling of W-La₂O₃ monoliths (d = 4 mm)
- casting with OFHC-Cu
- HIPing (700 °C, 3 hrs.)

HHF test

1000 cycles @ **18** MWm⁻²
without failure



Flat Tile Concept with and w/o W/Cu-Gradient



AIM

Reduction of residual and thermal stresses at the interface
($\Delta\alpha_{W/Cu} \approx 12 \times 10^6 \text{ K}^{-1}$) \Rightarrow reduced delamination effects

\Rightarrow **INCREASE OF LIFETIME**

Fabrication methods for W/Cu-FGMs

Investigated methods:

- **Vacuum Plasma Spraying**
- **Water Stabilized Plasma Spraying**
- **Direct Laser Deposition**

Other methods:

Electrochemical infiltration, Sintering, Spark Plasma Sintering,...



Vacuum Plasma Sprayed W/Cu-Composites

Parameters

- 2 powder feeders
- Transferred Arc Cleaning

Powder

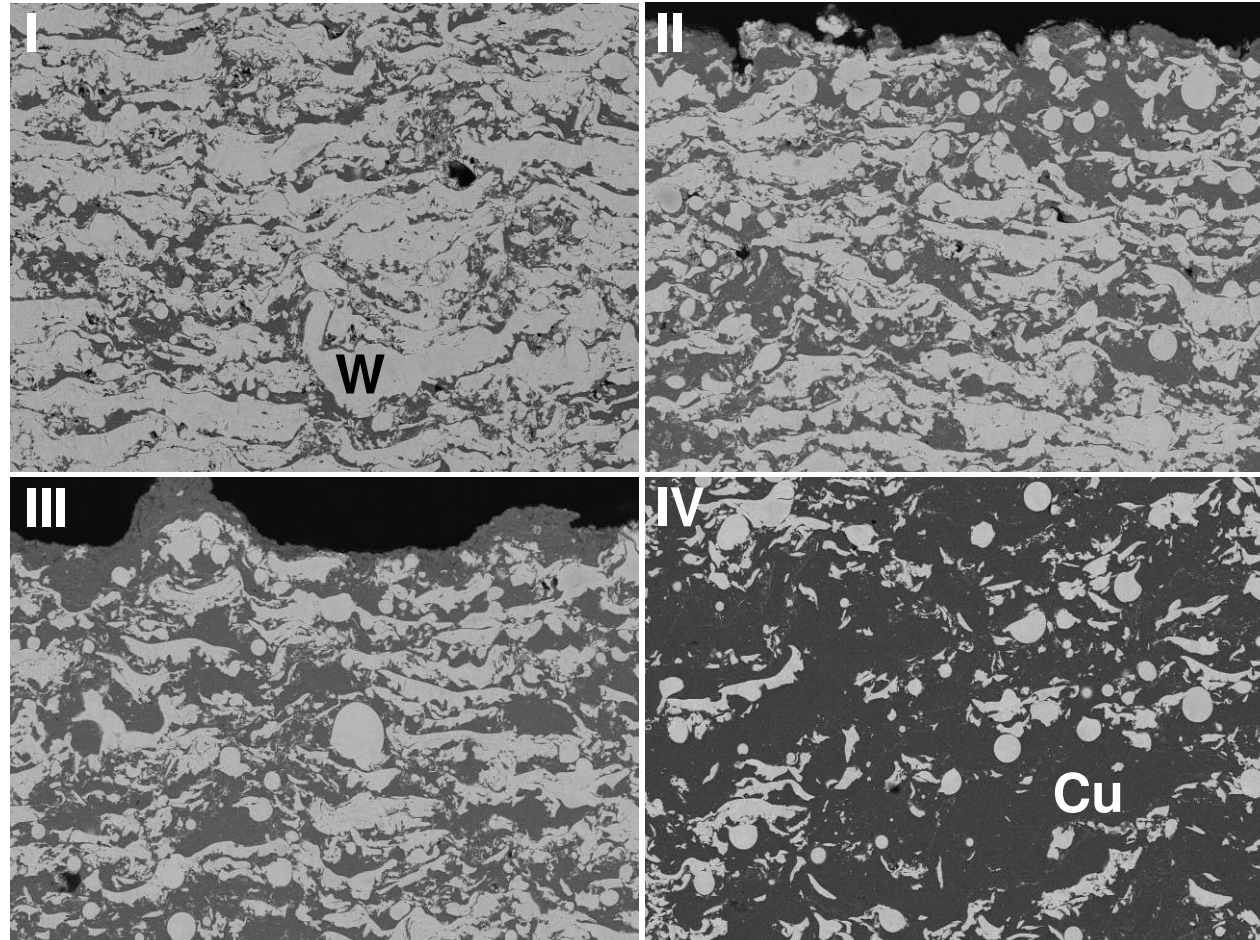
W [$< 10 \mu\text{m}$] +
Cu [40 - 50 μm]

I) W-Cu26

II) W-Cu43

III) W-Cu52

IV) W-Cu78

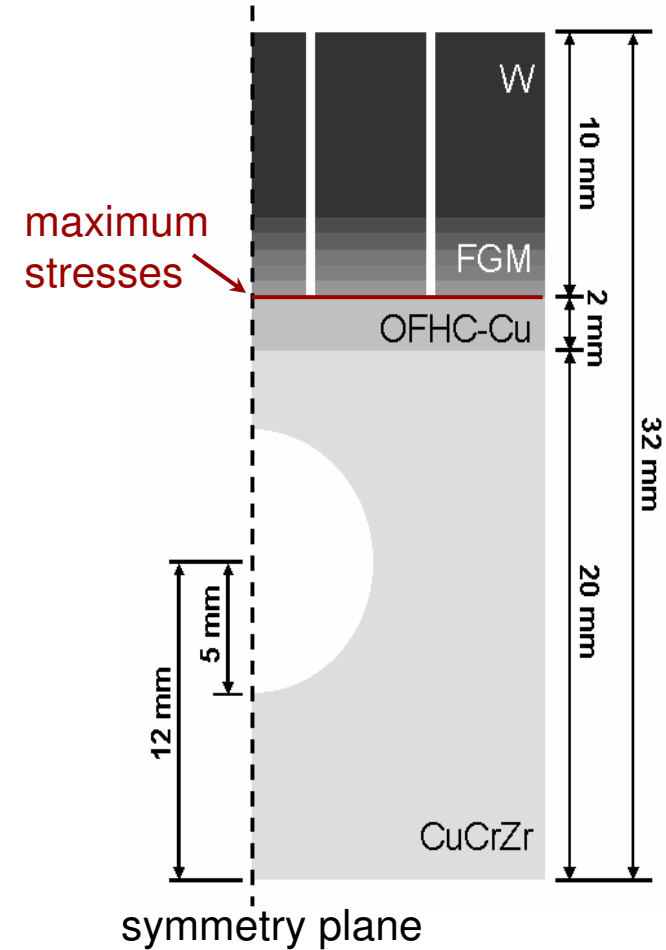
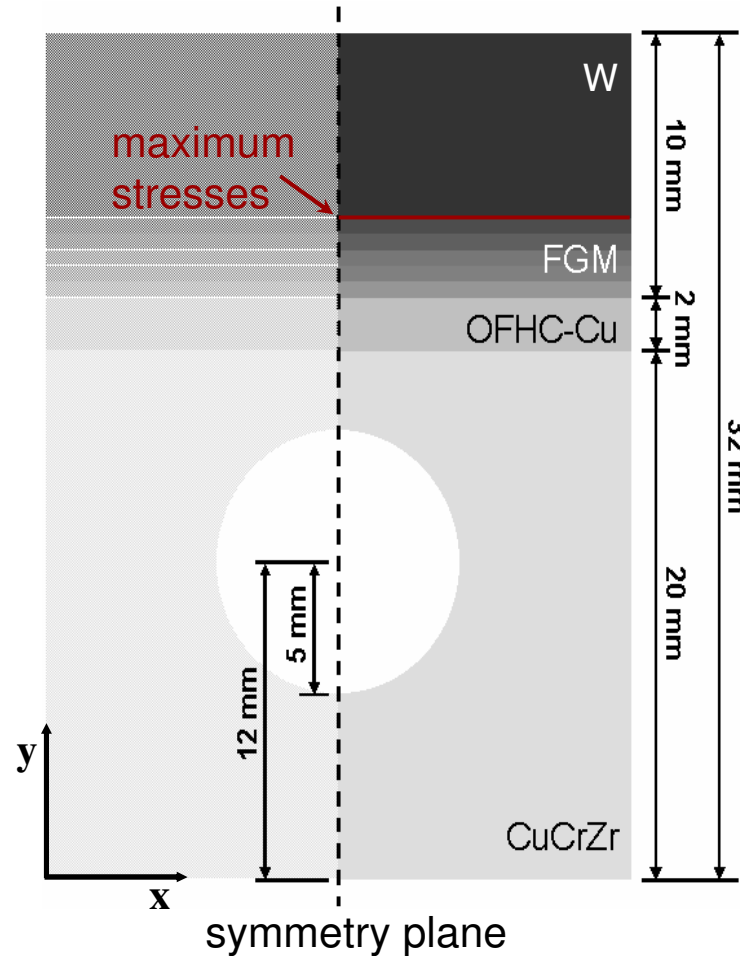


20 μm

Finite Element Simulations

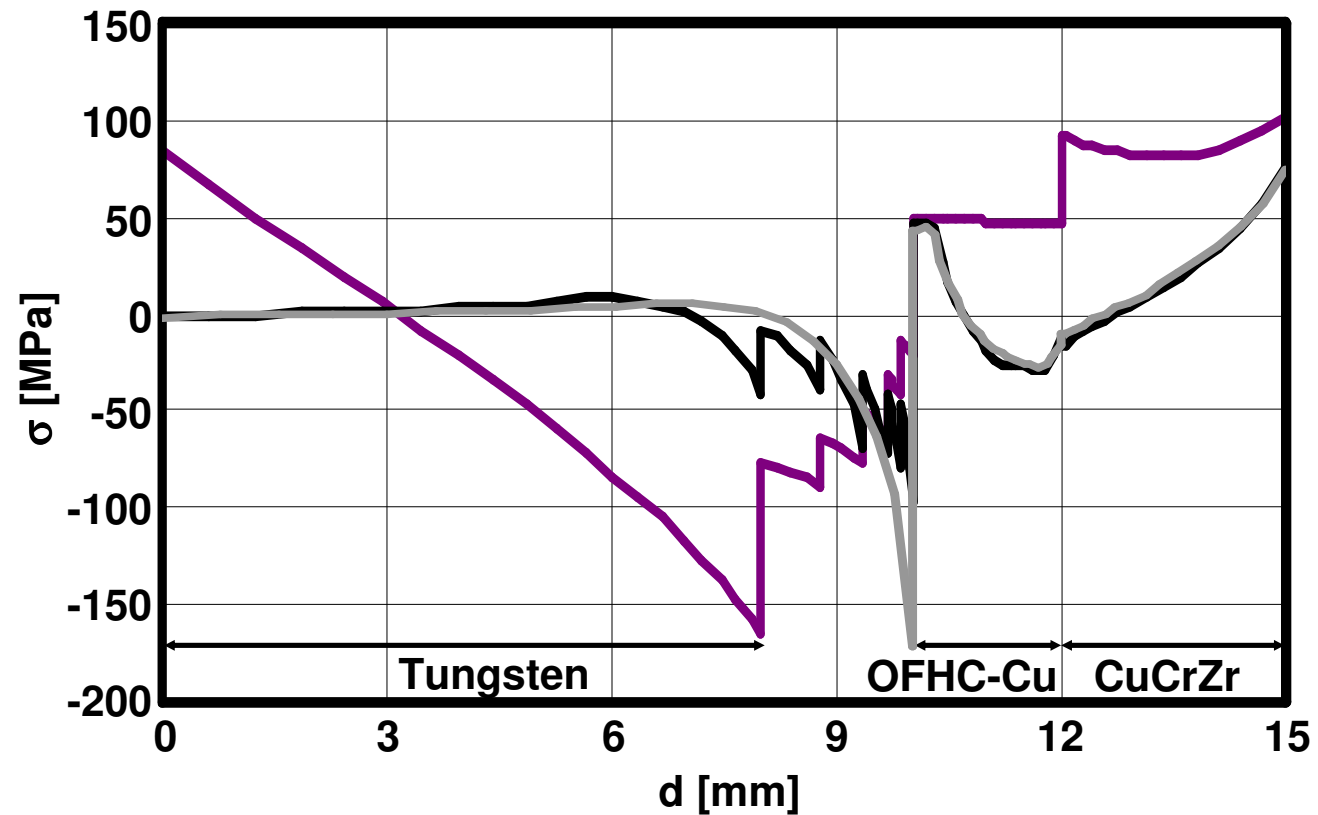
Parameters

- optimal bonding at the interfaces
- stress-free state at 500 °C
- loading: 5-20 MW/m²
- cooling: T = 100 °C
p = 4 MPa
twisted tape



Finite Element Simulations - Stresses

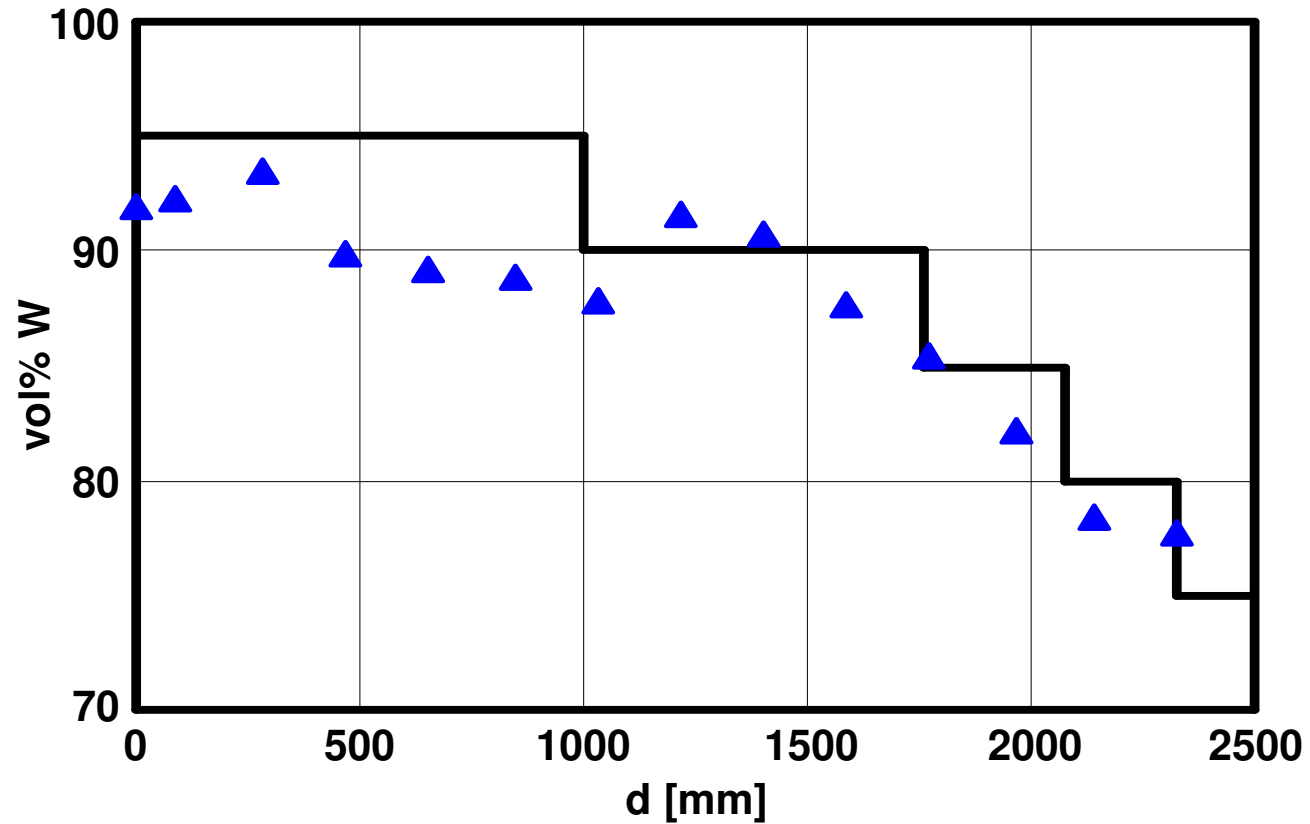
x-directional stresses; $P = 5 \text{ MW/m}^2$



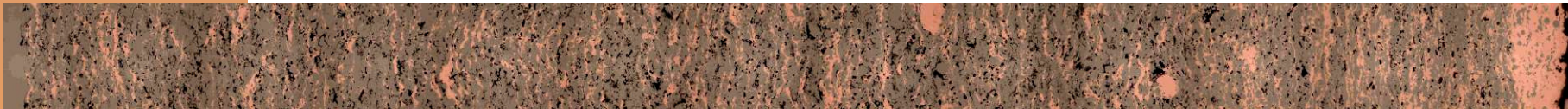
- ◆ FGM
- FGM + brush
- brush - w/o FGM



Vacuum Plasma Sprayed W/Cu-Gradient



◆ theoretical
▲ measured



200 μ m

Fabrication of Actively Cooled Components

- I. **Cu-coating** on the FGM
- II. **Ni-coating** on OFHC-Cu (both sides)
- III. Mounting of CuCrZr, OFHC-Cu and W+FGM in a **Cu-can** (vacuum)
- IV. **HIP** cycle: 3h, T = 550 °C
1h, T = 450 °C

Castellation

module A:

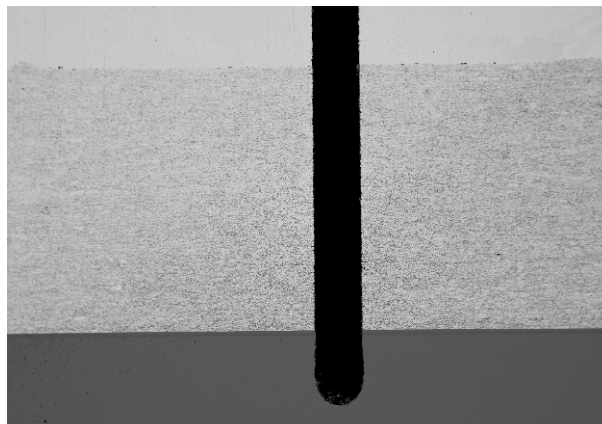
24 x 24 mm²

module B:

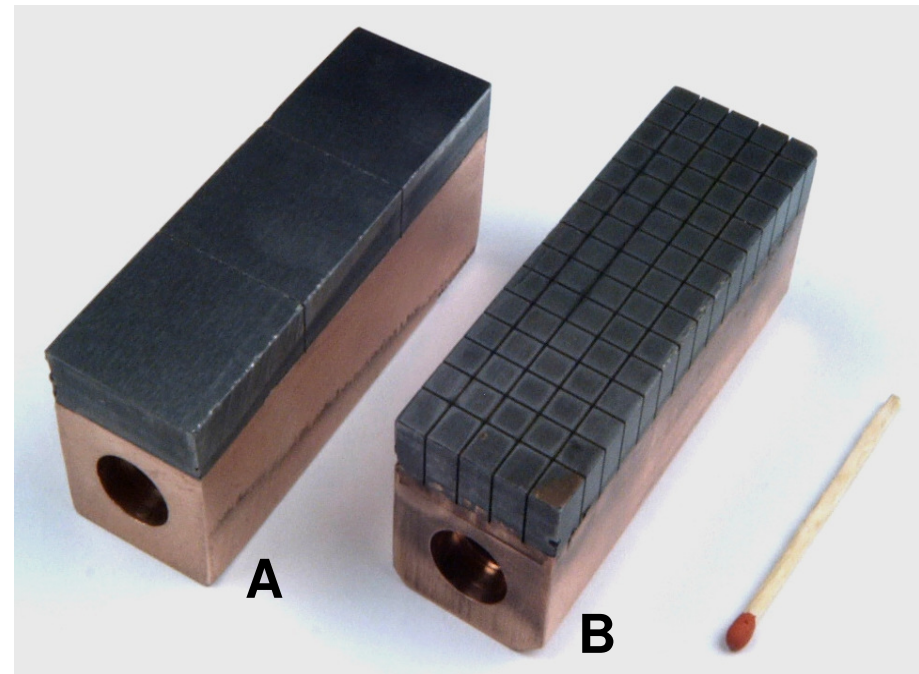
4.5 x 4.5 mm²

cutting width:

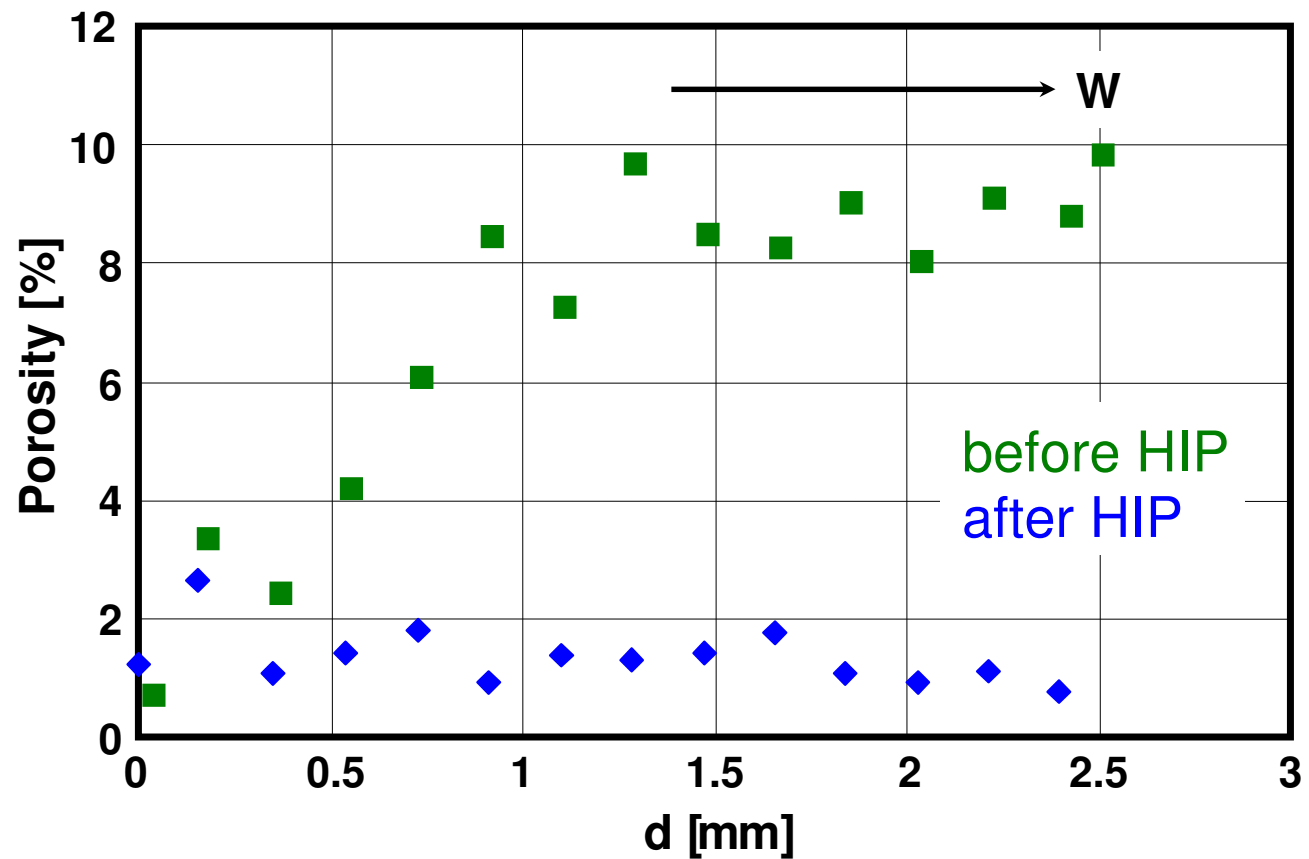
~0.35 mm



FZJ - IWW 2004 EHT = 16.00 kV Detector = BSE WD = 12 mm 1mm



Porosity in the Gradient

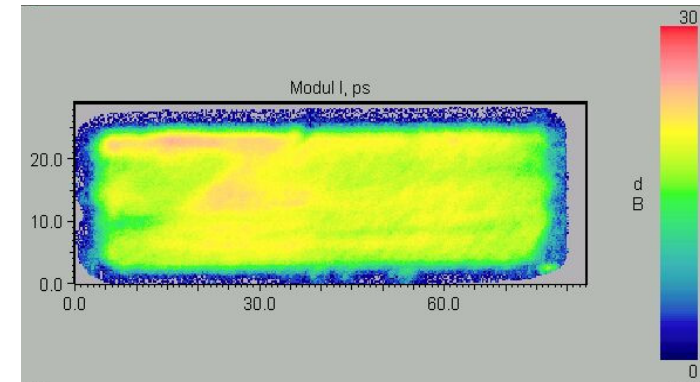
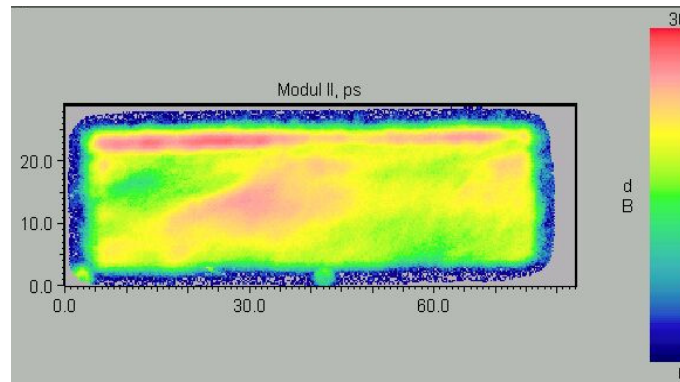


Interface Ultrasonic Inspection

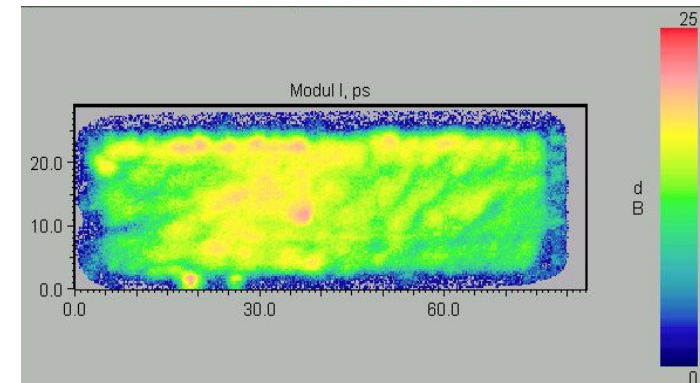
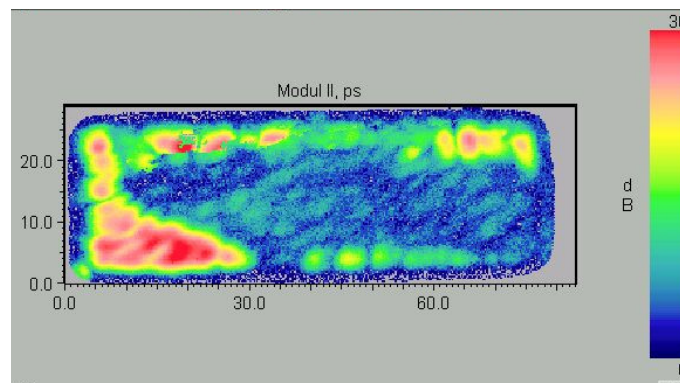
Module A

Module B

CuCrZr-OFHC-Cu interface



OFHC-Cu-FGM interface

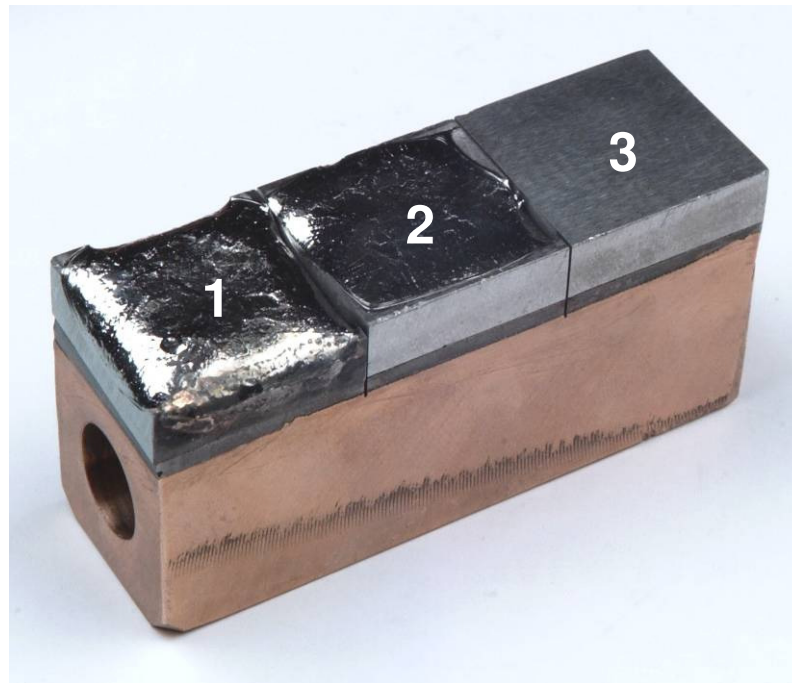


Screening Tests (1)

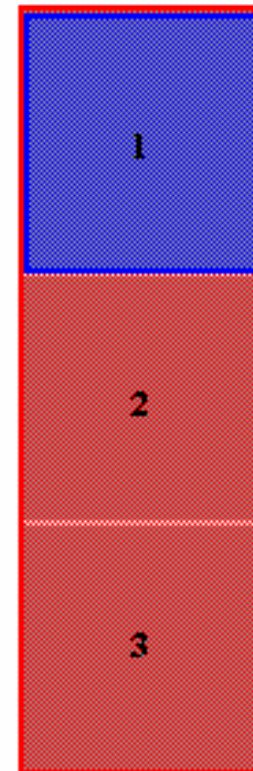
Electron beam loading: JUDITH (FZJ)

8 MW/m²: failure: brick 3

19.2 MW/m²: failure: brick 1



W- Oberfläche



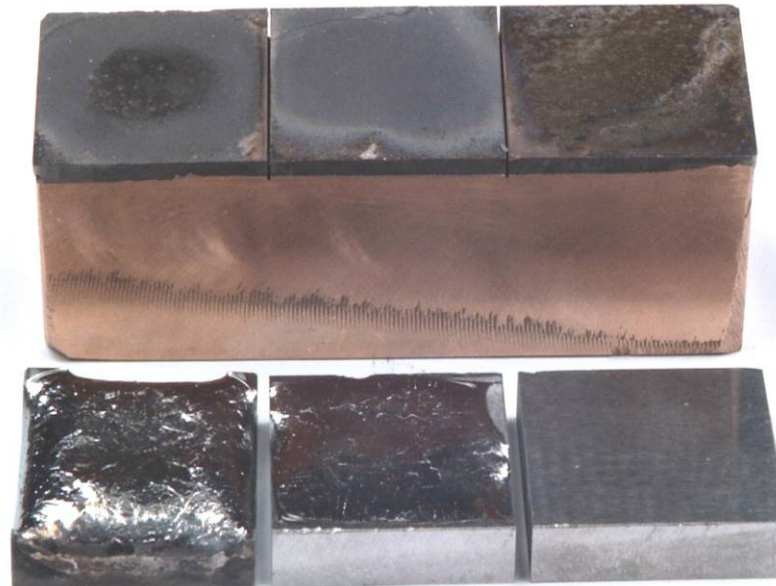
A = 1776 mm²

A = 583 mm²

Thermal Fatigue Tests (1)

Electron beam loading: JUDITH (FZJ)

14.8 MW/m²: 1 cycle, failure: brick 2



W- Oberfläche

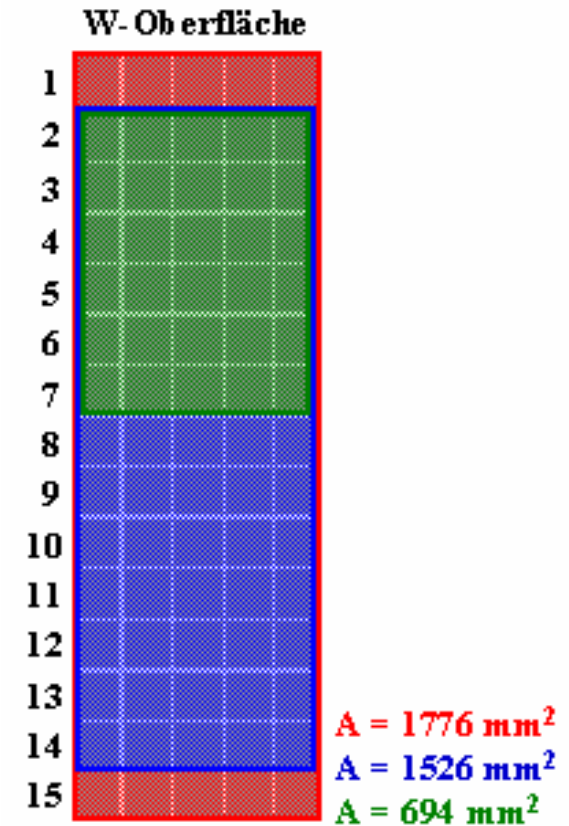
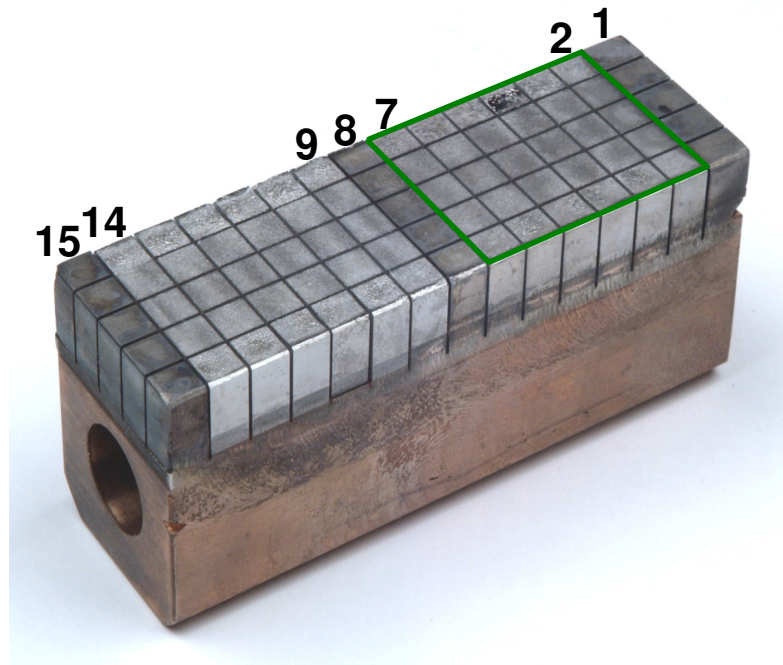


$A = 583 \text{ mm}^2$

Screening Tests (2)

Electron beam loading: JUDITH (FZJ)

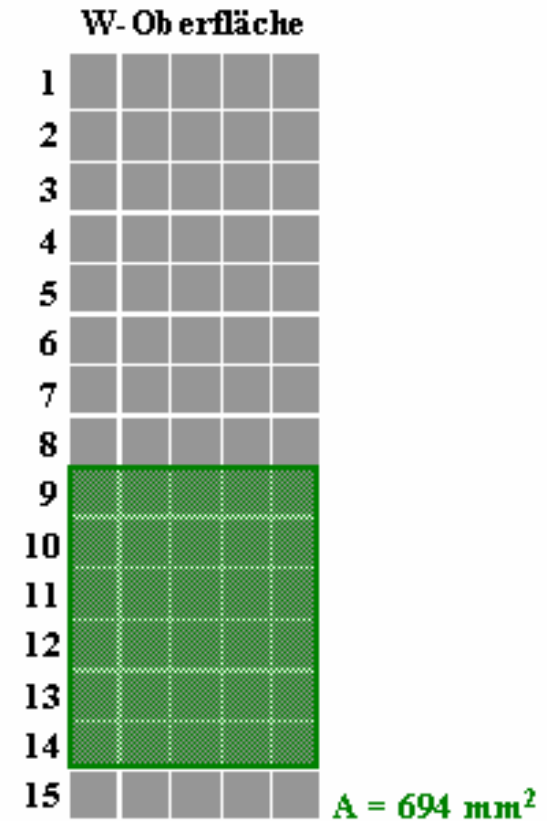
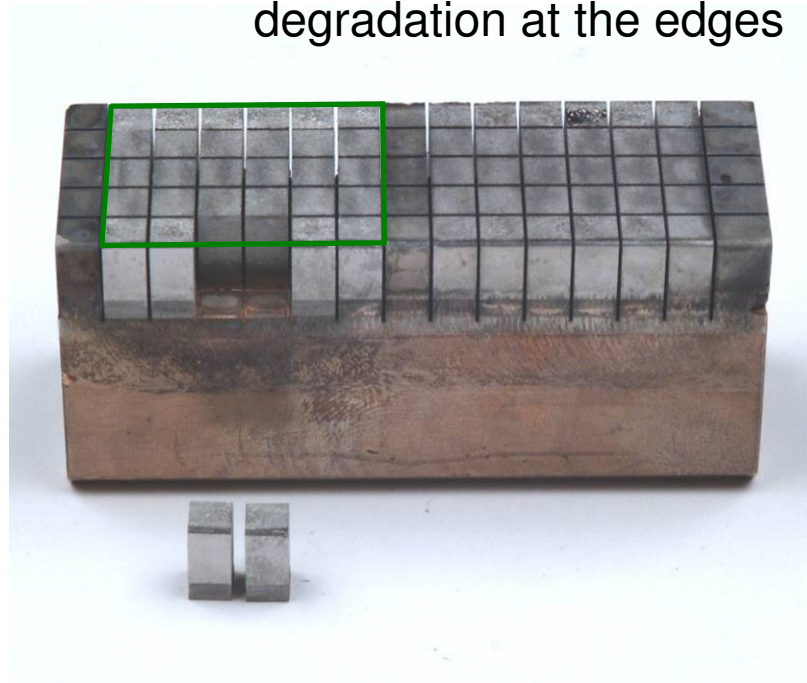
23.8 MW/m²: no degradation



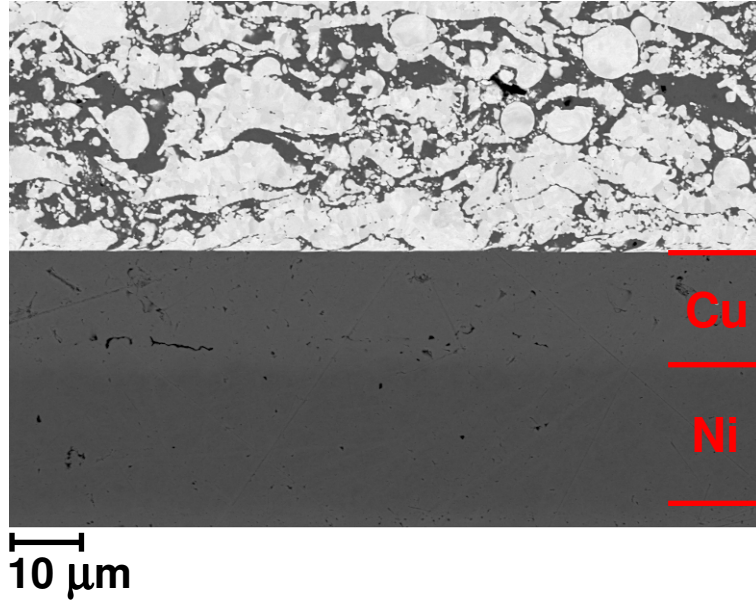
Thermal Fatigue Tests (2)

Electron beam loading: JUDITH (FZJ)

20 MW/m²: 100 cycles + 50 cycles
10 s loading, 20 s cooling
degradation at the edges



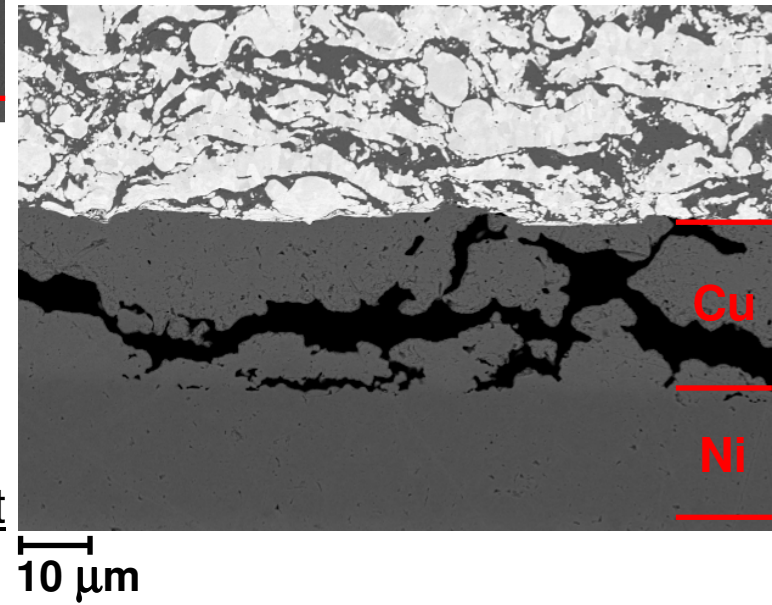
Failure Analysis



After Screening Test

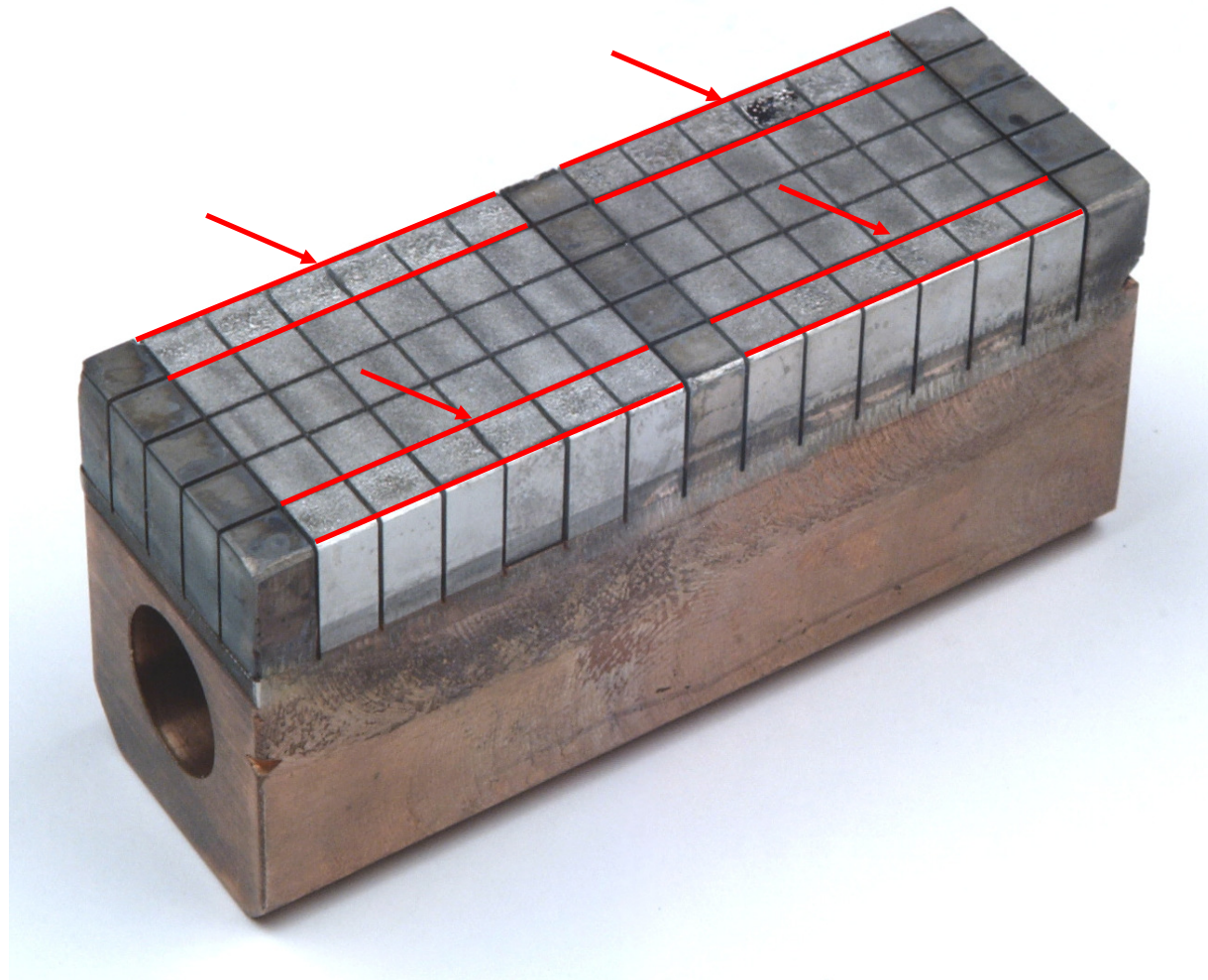
10 μm

After Thermal Fatigue Test

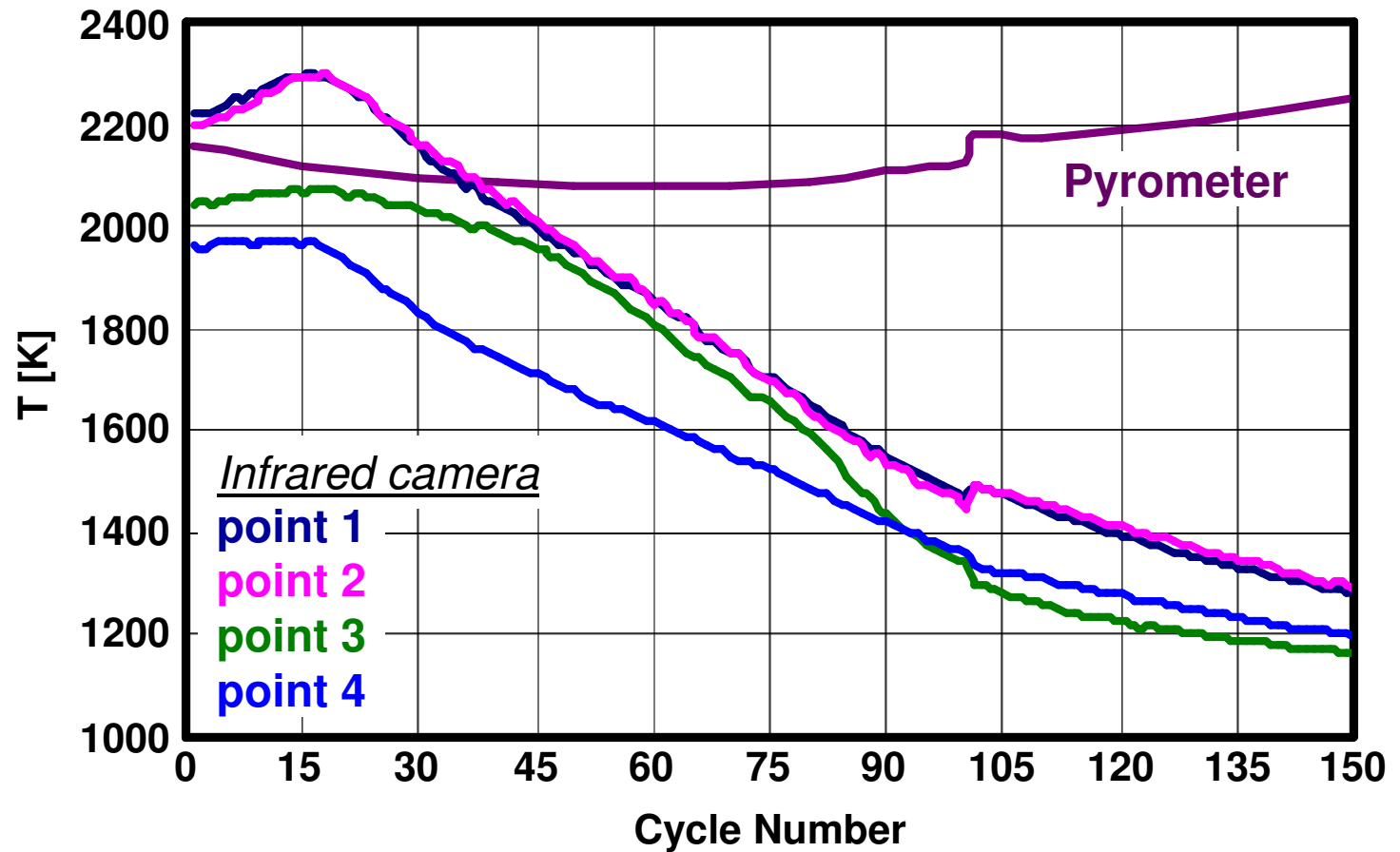


10 μm

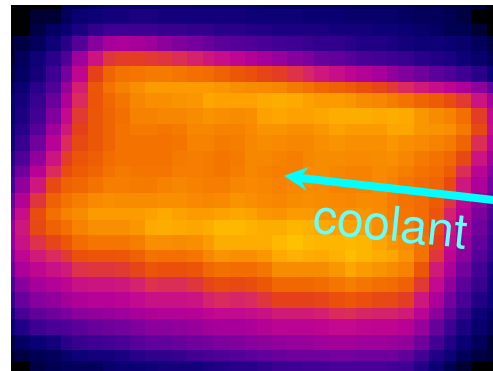
Surface Modification



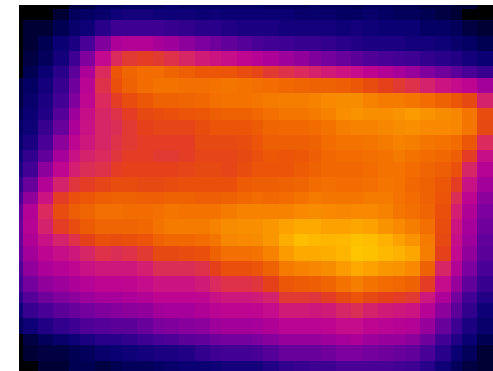
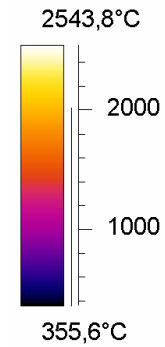
Temperature monitoring



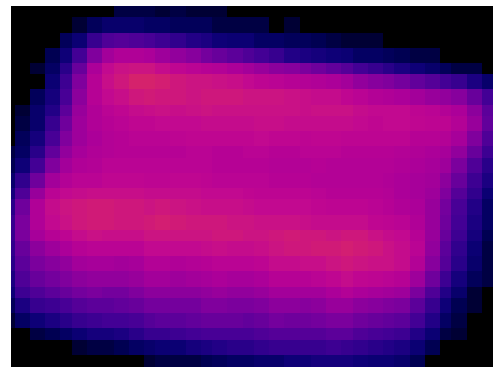
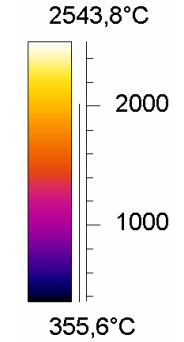
Thermal Fatigue Test – Infrared Pictures



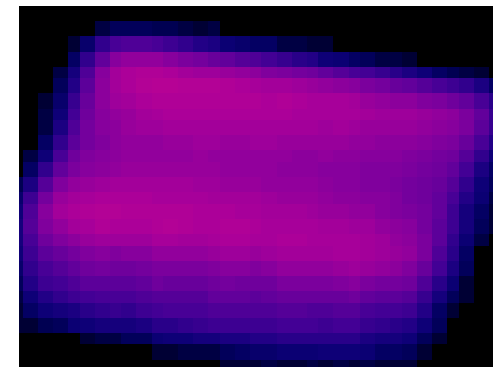
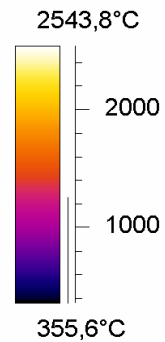
1. cycle



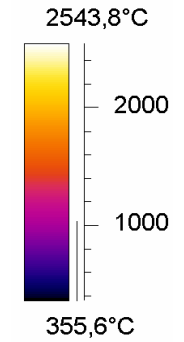
50. cycle



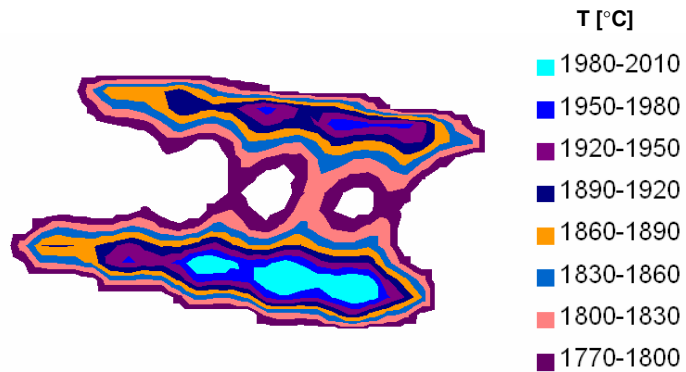
100. cycle



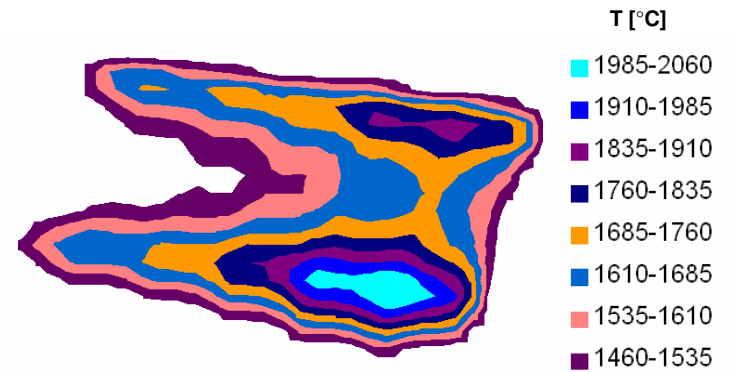
150. cycle



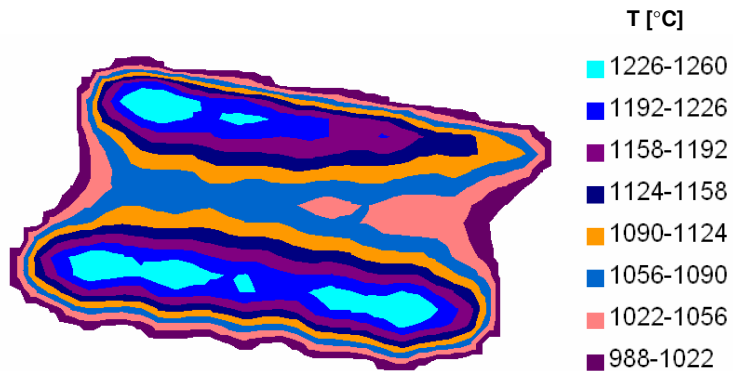
Thermal Fatigue Test – Temperature Graphs



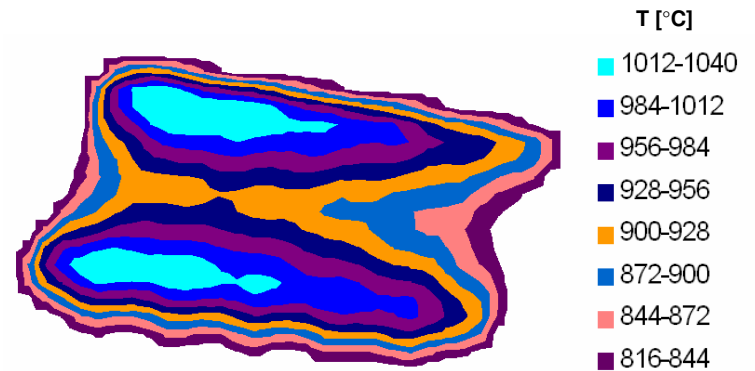
1. cycle



50. cycle



100. cycle



150. cycle

Conclusion

Vacuum plasma sprayed W/Cu-gradient: W-content > 75vol%

Castellation of the plasma facing material still necessary

High performance of test component: 150 cycles at 20 MW/m²

Full potential not yet reached

Problem

Castellated structure: critical joint between gradient and OFHC-Cu → not yet optimized





THE END!!!